

SPT-GU3412-SB2BD

GPON ONU SFP ClassB+ Transceiver

Features

- BiDi SFP Single Mode Transceiver
- SC receptacle is optional
- Comply with ITU-T G.984.2 Class B+
- Compliant with SFF MSA-2000 And SFF-8472 V10.3
- Single +3.3 Power Supply
- LVPECL Differential Data Inputs And CML Data Outputs
- LVTTL Signal Detection Output And LVTTL Burst Control
- Complies with Telcordia (Bellcore) GR-468-CORE
- 1310 nm Burst Mode Transmitter and 1490 nm Continuous Mode Receiver
- 1.244 Gbps DFB Laser Diode, 2.488 Gbps APD-TIA Receiver
- Maximal reach 20km

Applications

GPON ONU For P2MP Application

General

The SOPTO SPT-GU3412-SB2BD transceiver with BIDI SFP package supports typically 1.244 Gbps Tx,2.488 Gbps Rx Asymetric Data Rate for GPON ONU application up to 20km transmission distance, it's designed meeting with ITU-T G.984.2 Class B+. SC receptacle is for optical interface.

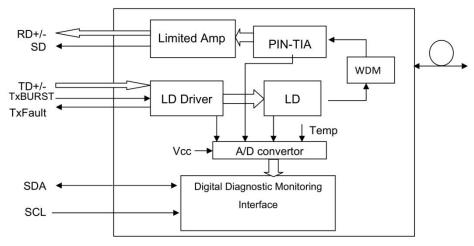
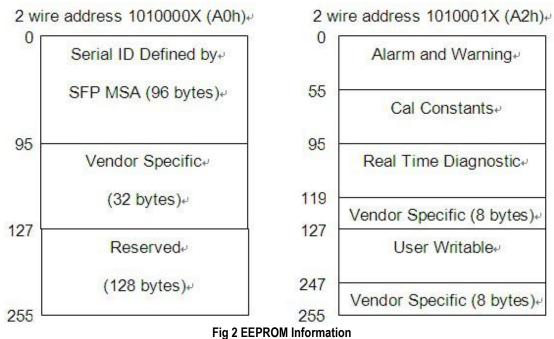


Fig 1 Transceiver Block Diagram



The module provides digital diagnostic information of its operating conditions and status, including transmitting power, laser bias, receiver input optical power, module temperature, and supply voltage. Calibration and alarm/warning threshold data are written and stored in internal memory (EEPROM). The memory map is compatible with SFF-8472, as shown in Fig. 2. The diagnostic data are raw A/D values and must be converted to real world units using calibration constants stored in EEPROM locations 56-95 in A2h.



Performance Specifications

Absolute Maximum Ratings									
Parameter	Symbol	Min.	Max.	Unit	Note				
Storage Temperature	Tst	-40	+85	°C					
Operating Case Temperature	Тс	0	70	°C	Standard				
Operating Case Temperature		-40	+85		Industrial				
Input Voltage	-	GND	Vcc	V					
Power Supply Voltage	Vcc-Vee	-0.5	+3.6	V					
Damage Threshold For Receiver	-	-	4	dBm					
Soldering Temperature / Time	-	-	260/10	°C/S					

Recommended Operating Conditions							
Parameter	Symbol	Min.	Typical	Max.	Unit	Note	
Power Supply Voltage	Vcc	3.135	3.3	3.465	V	-	
Operating Case	Тс	0	-	70	°C	Standard	
Temperature	10	-40	-	85		Industrial	
Total Supply Current	-	-		350	mA	-	

Optical Specification



Transmitter							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note	
Data Rate	DR	-	1.244	-	Gbps		
Optical Central Wavelength	1	1260	1310	1360	nm		
Spectral Width (-20dB)	Dl	-	-	1	nm		
Side Mode Suppression Ratio	SMSR	30	-	-	dB		
Average Optical Output Power	Po	0.5	-	5	dBm		
Extinction Ratio	Er	9	-	-	dB	-	
Tx Burst ON Time	Ton	-	-	12.86	ns	-	
Tx Burst OFF Time	Toff	-	-	12.86	ns	-	
Rise/Fall Time	Tr/Tf	-	-	250	ps	-	
Average Lauched Power of Off	Poff	_	_	-45	dBm	_	
Transmitter	1 011			-43	abili	_	
Output Eye	Complia	nt with l	TU-T G	.984.2			
Receiver							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note	
Data Rate	DR	-	2.488	-	Gbps		
Operate Wavelength	-	1480	-	1500	nm	-	
Sensitivity	Pr	-	-	-28	dBm	1	
Saturation	Ps	-8	-	-	dBm	1	
SD De-assert Level	-	-45	-	-	dBm	-	
SD Assert Level	-	-	-	-28	dBm	-	
SD Hysteresis	-	0.5	-	6	dB	-	
Optical Return Loss	-	-	-	-12	dB	-	
RSSI Range	-	-28	-	-8	dBm	-	
RSSI Accuracy	-	-3	-	+3	dB	-	

Note:

1.Minimum Sensitivity and saturation levels for a 2²³-1 PRBS. BER≤10⁻¹⁰ , 2.488Gpbs, ER=9dB

Electrical Specification									
Transmitter									
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note			
Differential Input Voltage	V _{IN-DIF}	300	-	1600	mV	-			
Tx Burst Input Voltage-Low	VIL	0	-	0.8	V	-			
Tx Burst Input Voltage-High	VIH	2.0	-	Vcc	V	-			
Receiver	Receiver								
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note			
Data Output Voltage Differential	VOUT-DIF	500	-	900	V	-			



Signal Detect Output Voltage-Low	VSD-L	0	-	0.8	V	
Signal Detect Output Voltage-High	VSD-H	2.0	-	Vcc	V	-

EEPROM Information

EEPROM Serial ID Memory Contents (A0h)

Addr. (decimal)	Field Size (Bytes)	Name of Field	Content (Hex)	Content (Decimal)	Description
0	1	Identifier	03	3	SFP
1	1	Ext. Identifier	04	4	MOD4
2	1	Connector	01	01	Receptacle
3-10	8	Transceiver	00 00 00 80 00 00 00 00	00 00 00 128 00 00 00 00	Transmitter Code
11	1	Encoding	01	1	8B10B
12	1	BR, nominal	0C	12	1.25Gbps
13	1	Reserved	00	0	-
14	1	Length (9um)-km	14	20	20km
15	1	Length (9um)	C8	200	20km
16	1	Length (50um)	00	0	-
17	1	Length (62.5um)	00	0	-
18	1	Length (copper)	00	0	-
19	1	Reserved	00	0	-
20-35	16	Vendor name	Omitted	Omitted	'SOPTO' (ASCII)
36	1	Reserved	00	0	-
37-39	3	Vendor OUI	00 00 00	0 0 0	-
40-55	16	Vendor PN	Omitted	Omitted	SPT-EU3411-SE2 AD (ASCII)
56-59	4	Vendor rev	30 30 30 20	48 48 48 32	"000" (ASCII)
60-61	2	Wavelength	05 1E	05 30	1310
62	1	Reserved	00	0	-
63	1	CC BASE	-	-	Check sum of bytes 0 - 62
64	1	Reserved	00	0	
65	1	Options	1C	28	
66	1	BR, max	00	0	-
67	1	BR, min	00	0	-
68-83	16	Vendor SN	-	-	ASCII
84-91	8	Vendor date	-	-	Year (2 bytes), Month (2 bytes), Day (2 bytes)
92	1	DDM Type	58/68	88/104	External/Internal Calibrated
93	1	Enhanced Option	B0	176	LOS, TX_FAULT



					and Alarm/warning flags implemented
94	1	SFF-8472 Compliance	03	3	SFF-8472 Rev 10.3
95	1	CC EXT	-	-	Check sum of bytes 64 - 94
96-255	160	Vendor spec			

Alarm and Warning Thresholds (Serial ID A2H)

Parameter(Unit)	C Temp (°C)	I Temp (°C)	Voltage (V)	Bias (mA)	TX Power (dBm)	RX Power (dBm)
High Alarm	100	100	3.6	90	5	-8
Low Alarm	-10	-40	3	0	0.5	-28
High Warning	95	95	3.5	70	4	-9
Low Warning	0	-30	3.1	0	1	-27

Digital Diagnostic Monitor Accuracy

Parameter	Unit	Accuracy	Range	Calibration
		. 2	Po: -Pomin∼Pomax dBm,	External/Int
Tx Optical Power	dB	±3	Recommended operation conditions	ernal
		. 2	Pi: Ps~Pr dBm, Recommended	External/Int
Rx Optical Power	dB	±3	operation conditions	ernal
		. 10	Id: 1-100mA, Recommended	External/Int
Bias Current	%	±10	operating conditions	ernal
Power Supply		. 2		External/Int
Voltage	%	±3	Recommended operating conditions	ernal
Internal	%0	. 2		External/Int
Temperature	\mathbb{C}	±3	Recommended operating conditions	ernal

PIN Diagram



20 VeeT	1 VeeT
19 TD-	2 TxFault
18 TD+	3 Tx_Burst
17 VeeT	4 SDA
16 VccT	5 SCL
15 VccR	6 Mod_Det
14 VeeR	7 TX SD
13 RD+	8 LOS
12 RD-	9 P_DOWN
11 VeeR	10 VeeR
Top of Board	Bottom of Board

PIN Description

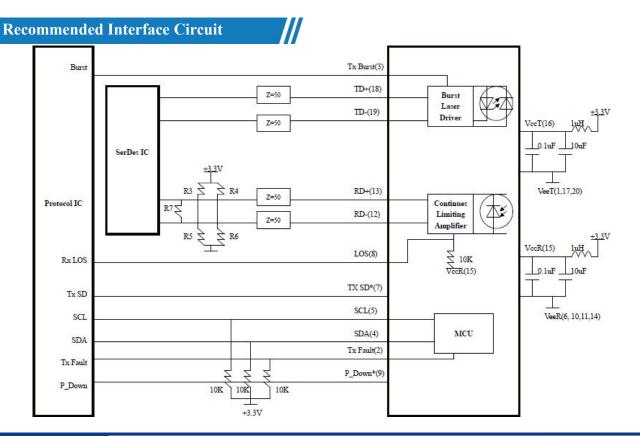
Pin No.	Name	Function	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	
2	Tx Fault	Transmitter Fault Indication	3	Note 1
3	Tx Burst	Transmitter Burst Mode Control.	3	Note 2
4	SDA	Module Definition 2	3	Note 3
5	SCL	Module Definition 1	3	Note 3
6	MOD-DET	Module Definition 0	3	Note 3
7	TX SD	Tx Transmitter State Indication, assert When Tx ON. Optional	3	
8	LOS	Los Of Signal	3	Note 4
9	P_DOWN	Power Down, NC/High=Normal operation ,Low=Power down. Optional	1	
10	VeeR	Receiver Ground	1	Note 5
11	VeeR	Receiver Ground	1	Note 5
12	RD-	Inv. Receiver Data Out	3	Note 6
13	RD+	Receiver Data Out	3	Note 6
14	VeeR	Receiver Ground	1	Note 5
15	VccR	Receiver Power Supply	2	Note 7, 3.3V± 5%
16	VccT	Transmitter Power Supply	2	Note 7, 3.3V± 5%
17	VeeT	Transmitter Ground	1	Note 5
18	TD+	Transmitter Data In	3	Note 8
19	TD-	Inv.Transmitter Data In	3	Note 8
20	VeeT	Transmitter Ground	1	Note 5



Notes:

- 1. TX Fault is an open collector/drain output, which should be pulled up with a $4.7K-10K\Omega$ resistor on the host board. Pull up voltage between 2.0V and VccT, R+0.3V. When high, output indicates a laser fault of some kind. Low indicates normal operation. In the low state, the output will be pulled to < 0.8V.
- 2. TX Burst is an input that is used to enable/disable the transmitter optical output. Burst Logic '1' or Logic '0' Tx on ,pleaser refer to order information

- 3. Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a $4.7K 10K\Omega$ resistor on the host board. The pull-up voltage shall be VccT or VccR.
 - Mod-Def 0 is grounded by the module to indicate that the module is present
 - Mod-Def 1 is the clock line of two wire serial interface for serial ID
 - Mod-Def 2 is the data line of two wire serial interface for serial ID
- 4. LOS (Loss of Signal) is an open collector/drain output, which should be pulled up with a $4.7K 10K\Omega$ resistor. Pull up voltage between 2.0V and VccT, R+0.3V. When high, this output indicates the received optical power is below the worst-case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output will be pulled to < 0.8V.
- 5. VeeR and VeeT may be internally connected within the SFP module.
- 6. RD-/+: These are the differential receiver outputs. They are DC coupled 100Ω differential lines which should be terminated with 100Ω (differential) at the user SERDES.
- 7. VccR and VccT are the receiver and transmitter power supplies. They are defined as 3.3V ±5% at the SFP connector pin. Maximum supply current is 450mA. Recommended host board power supply filtering is shown below. Inductors with DC resistance of less than 1Ω should be used in order to maintain the required voltage at the SFP input pin with 3.3V supply voltage. When the recommended supply filtering network is used, hot plugging of the SFP transceiver module will result in an inrush current of no more than 30 mA greater than the steady state value. VccR and VccT may be internally connected within the SFP transceiver module.
- 8. TD-/+: These are the differential transmitter inputs. They are DC-coupled, differential lines with 100Ω differential termination inside the module.





Note:

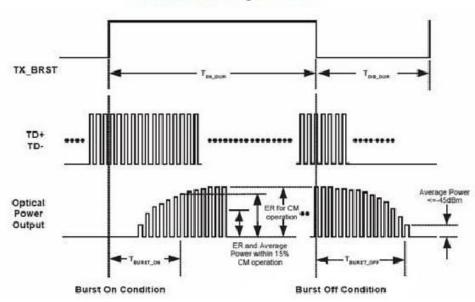
Tx: DC coupled internally.

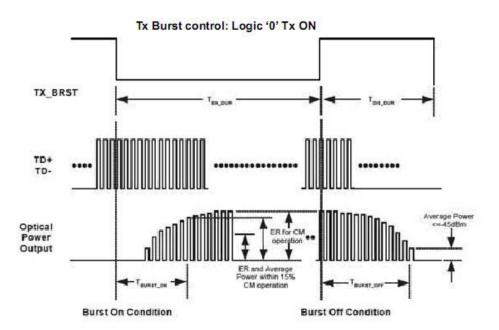
Rx: AC coupled internally.

Input stage in SerDes IC with internal bias to Vcc-1.3V R3=R4=R5=R6=N.C, R7=100 Ω Input stage in SerDes IC without internal bias to Vcc-1.3V R3=R4=82 Ω ,R5=R6=130 Ω ,R7=N.C

Burst Mode Sequence Definition

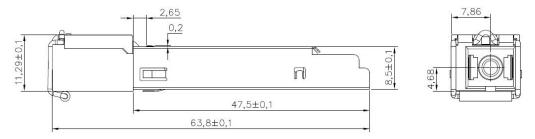
Tx Burst control: Logic '1' Tx ON

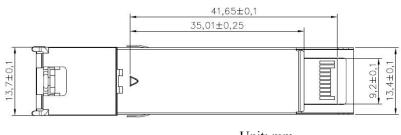


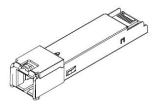


Mechanical Dimensions



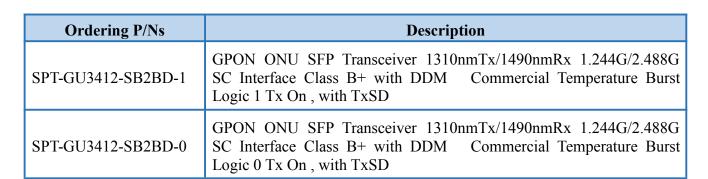






Unit: mm

Ordering information



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